

V F Type 5.0 x 3.2mm SMD Voltage Controlled Crystal Oscillator

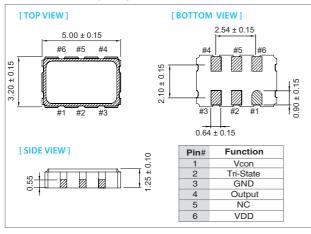
FEATURE

- Typical 5.0 x 3.2 x 1.25 mm 6 pads ceramic SMD package.
- Tight symmetry (45 to 55%) available.
- Operating temperature up to 105°C
- Tri-state enable/disable

TYPICAL APPLICATION

- Set-top Box, HDTV
- WIMAX/WLAN
- xDSL/ VoIP, Cable modem

DIMENSION (mm)



ELECTRICAL SPECIFICATION

Parameter	3.3V			
Farameter	Min	Max.	Unit	
Supply Voltage Variation (VDD)	Vdd-5%	VDD+5%	V	
Frequency Range	1.5	170	MHz	
Standard Frequency		19.44, 38.4		
Absolute Pulling Range (APR)	±50	-	ppm	
Control Voltage Range	0.3	3.0	V	
Supply Current 1.5 MHz ≤ Fo < 20 MHz	-	10		
20 MHz ≦ Fo < 50 MHz	-	20	mA	
50 MHz ≦ Fo≦ 170 MHz	-	30		
Output Level Output High (Logic"1")	2.97	-	V	
Output Low (Logic"0")	-	0.33	•	
Transition Time: Rise/Fall Time+				
1.5 MHz ≦ Fo < 20 MHz		5	-	
20 MHz ≦ Fo < 50 MHz		4	nSec	
50 MHz ≦ Fo ≦ 170 MHz	-	3		
Start Time	-	2	mSec	
Tri-State (input to Pin 2)	0.01			
Enable (High voltage or floating) Disable (Low voltage or GND)	2.31	0.99	v	
Linearity			%	
Modulation Bandwidth (BW)	-	10	-70	
$1.5 \text{ MHz} \leq \text{Fo} \leq 170 \text{ MHz}$	15		kHz	
Input Impedance	10000	_	kΩ	
Period Jitter (Pk-Pk)	-	40	pSec	
RMS Phase Jitter (Integrated 12 kHz ~ 20 MHz)	-	1	pSec	
Phase Noise@38.4 MHz 100 Hz	-100			
1 kHz	-133		dBc/Hz	
10 kHz	-133		0.20/112	
Aging (@ 25°C 1st year)	- 12		ppm	
	-	±3		
Storage Temp. Range	-55	125	°C	

Standard frequencies are frequencies which the crystal has been designed and does not imply a stock position.

+ Transition times are measured between 10% and 90% of VDD, with an output load of 15pF.

FREQ. STABILITY vs. TEMP. RANGE

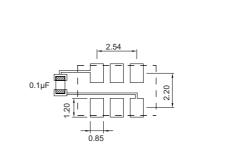
	Temp. (°C)	±25	±50			
[-10 ~ +60	0	0			
[-20 ~ +70	0	0	* ⊖: Available ∆:Conditional X: Not available		
[-40 ~ +85	×	0	* Inclusive of calibration @ 25 °C, operating temperature range, input		
	-40 ~ +105	×	0	voltage variation, load variation, aging (1 st year), shock, and vibration		

Note: not all combination of options are available. Other specifications may be available upon request.

Specifications subject to change without notice.



SOLDER PAD LAYOUT (mm)



To ensure optimal oscillator performance, place a by-pass capacitor of $0.1 \mu F$ as close to the part as possible between Vdd and GND pads.